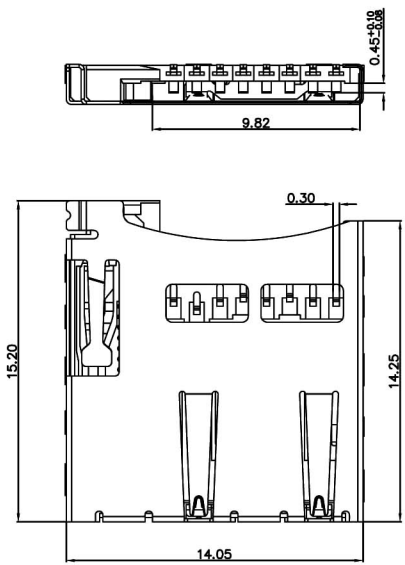


1 2 3 4 5 6 7 8

A



B

C

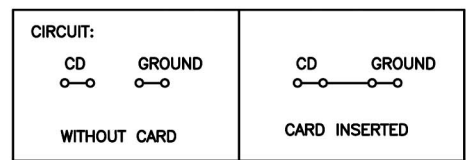
D

E

F

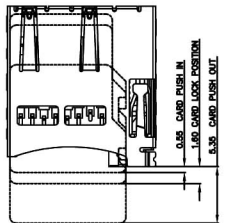
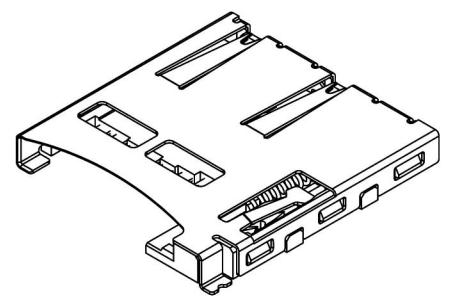
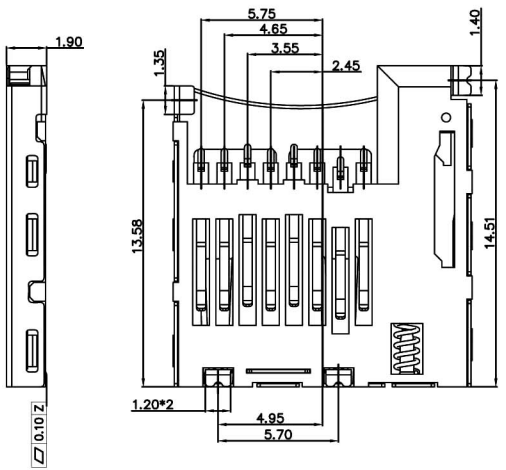
G

H

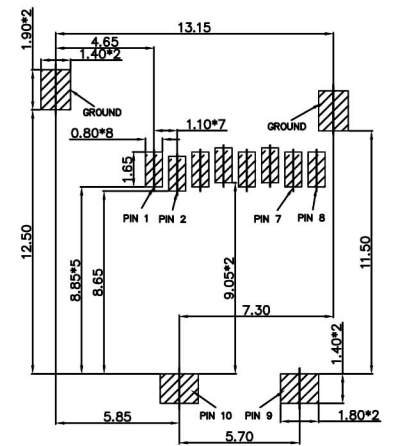


PIN ASSIGNMENT AS BELOW TABLE:

PIN NO.	NAME	TYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)
9	CARD DETECT		
10			



2:1



RECOMMENDED PCB LAYOUT
TOLERANCE:±0.05

NOTES:

- MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0,
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
- PLATING:
UNDERPLATE: NICKEL.
CONTACT AREA: GOLD OVER NICKEL.
SOLDER AREA: TIN OVER NICKEL.
- PARTS TO BE FULFILLED ROHS REQUIREMENTS.

RoHS Compliant	HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
	APPD. 核准 DWG. 製圖 DATE 制表日 2015/03/04	SCALE 比例 Hedy UNIT 單位 M M PAGE 張數 1 / 1
PART NAME 品名 T-FLASH CONNECTOR 8P PUSH-PUSH TYPE SMT TYPE STAND OFF 0mm SELECTIVE GOLD PLATING W/O LOCATING PEG BLACK COLOR REEL PACKING ROHS PART NO. 料號 C0622-08DAXNBRR		

1 2 3 4 5 6 7 8